

The world's most accurate printer provides extraordinary performance.



# **MPM**

# Accela® Stencil Printer

The premier printing platform for the perfect balance of throughput and quality

# **MPM**

# Accela

# OEM and CEM manufacturers face shrinking profits and ferocious competition. They need a printing solution that maximizes uptime, improves final product yield, generates more quality boards per hour, and increases the return on their capital investment. The Accela

printer is that solution.

# Introducing the World's Most Advanced Stencil Printer



## **Increasing Throughput and More**

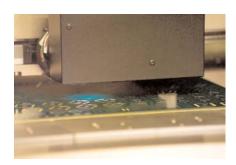
The MPM® Accela printer from Speedline is the ultimate printing solution for manufacturers of high-volume, high-technology circuit boards. Accela processes the largest, thinnest or most complex boards with unprecedented speed, accuracy and ease. Its leading edge design incorporates the best features of our proven platforms and includes 11 patents and patent-pending innovations.

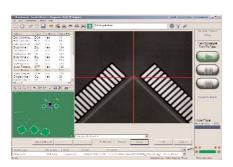
An industry break-through, parallel processing, allows critical operations to occur simultaneously, not serially, resulting in unmatched raw throughput - gains of 20% or more good boards per hour! But Accela doesn't stop there. Other advantages include:

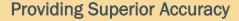
- · Highest accuracy and repeatability
- Advanced consumables management for fast setup and changeover
- Proven reliability
- Outstanding flexibility and ease of use

# Advanced High-speed, Post-print Inspection

The Accela incorporates SpeedVision™, the industry-leading throughput enhancement to Speedline's patented texture-based 2D inspection tools, BridgeVision® and StencilVision™. Instead of a device-by-device approach, this unique system uses full, field-of-view image acquisition and advanced camera motion techniques to achieve unparalleled inspection capabilities at line speed. Speedvision inspects angular devices, detects bridging and logs quantitative component and program level data into the standard, on-board SPC package.







Accela's substantial yield improvement over traditional printers isn't solely due to the parallel processing that allows increased inspection frequency. The critical metric isn't just boards per hour: it's good boards per hour.

Accela delivers 12.5 micron accuracy at 6 sigma for alignment and 25 microns at 6 sigma for printing performance. That precision reduces waste from errors and bad boards. It also makes it the most accurate, repeatable stencil printer ever — a fact verified by an independent, third-party testing company. This unsurpassed performance provides both the highest throughput and the greatest yield for even the most difficult applications. This is especially important as the lead-free transition presents additional challenges for the printing process.



MPM S Accela

Speedline

## CANopen Controls

Electrical architecture that supports parallel processing to maximize throughput.

### Frame

TO THE ST

Zanite<sup>™</sup> material provides solid foundation for superior accuracy and repeatability.

### **Traceability and Verification**

Process control is the cornerstone of quality production. Among the Accela's many process control tools is barcode reading capability for product traceability and process verification. A machine-mounted barcode scanner reads and stores board data from anywhere on the substrate to provide traceability for SPC. A handheld barcode reader is offered to scan stencil, paste, blades, tooling, boards, and pump size to provide process verification and prevent entry into production if incorrect materials are scanned.

### **Supplying Significant Cost Savings**

Certainly higher yield performance promises quicker payback. But this printer is built to lower users' cost of ownership in every other way as well.

It is designed to optimize consumables management while minimizing downtime to increase utilization. It is easy to use, easy to service, and is constructed to provide the lowest maintenance costs of any printer in its class.

### Offering Robust Reliability

Manufacturers producing critical-specification assemblies demand assured uptime and long service life. Accela fulfills their strictest requirements. It's a solid platform that performs the most challenging customer tasks with exceptional reliability. The base configuration of the Accela provides a comprehensive set of capabilities. With a broad option set, it can be configured to meet any manufacturing challenge.

Feature	Standard	Option
Windows® XP Operating System	Χ	
Benchmark Software	Χ	
SPC Data Collection	Χ	
Closed-Loop Squeegee Head	Χ	
CANopen Control System	Χ	
Adjustable Stencil Shelf	Χ	
Look-Up/Look-Down Vision*	Χ	
Vacuum Wiper* with Solvent Capability	Χ	
Flat-Panel Display	Χ	
Three Stage Transport Rail System	Χ	
Rheometric Pump*		Χ
Automatic Paste Dispenser		Χ
Temperature Control Unit		Χ
Pad Coverage 2D Inspection		Χ
Texture-Based BridgeVision and StencilVision™*		Χ
Product Traceability (w/Externally mounted barcode)		Χ
Process Verification (w/Handheld barcode scanner)		Χ
Gel-Flex® Tooling*		Χ







### The Flexibility to Handle Any Job

The new Accela platform handles a myriad of applications - from printing on the highest-density, most complex boards to meeting lead-free manufacturing requirements.

It offers the operator tool-free hardware interfaces with a modular design featuring CANopen electronic architecture for advanced communications and easy maintenance and upgradeability. On the software side, Accela features an exclusive, easy-to-use Benchmark graphical user interface running under Windows XP for effortless networking.

# **Creating a New Standard**

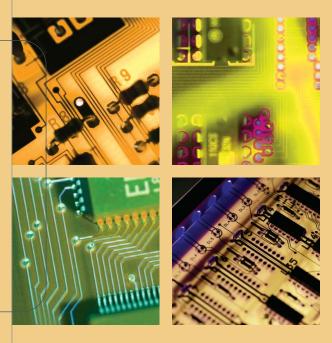
Printer cycle time is a common metric used throughout the industry. But cycle time is only a single factor in printer productivity — perhaps not even the most important. What about board handling time, print process parameters, squeegee use, stencil cleaning, and other critical elements?

A standard based on throughput is needed. One that takes into account all critical factors to establish a truly useful measure of printer productivity.

With the innovative MPM Accela stencil printer, that new standard becomes a reality. Simply put, Accela produces more good boards per hour.

Aided by unique parallel processing, its throughput is unmatched. And Accela's design minimizes every single source of downtime: product setup, product changeovers, consumables replenishment, maintenance, and repairs. Result: throughput gains of more than 20% over the nearest competitor.

LIKE NO OTHER
PRINTER ON THE
MARKET, ACCELA TRULY
OPTIMIZES THE QUALITY,
NUMBER, AND COST OF
BOARDS PRODUCED PER
HOUR.



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MPM ACC	ELA SPI	ECIFICAT	<u>IONS</u>
BOARD HAN	IDLING		

BUARD HANDLING	
Maximum Board Size (X x Y)	558 mm x 508 mm (22" x 20")
Minimum Board Size (Y x X)	50.8 mm x 50.8 mm (2" x 2")
Board Thickness	0.152 mm (0.006") to 12.7 mm (0.500"), excluding warpage tolerance
Maximum Board Weight	7 kg (15 lb)
Board Edge Clearance	Configurable to 3 mm (0.120") or 5 mm (0.200")
Maximum Underside Clearance	25 mm (1.0")
Transport Speed	8 mm/sec to 1270 mm/sec (0.3"/sec to 50"/sec)
Transport Height From Floor	813 mm to 1041 mm (32" to 41")
Transport Track Feed Direction	Left-Right, Right-Left, Right-Right, Left-Left
Conveyor Length	Choice of 1416 mm (55.7"), 1727 mm (68"), or 2048 mm (80.6")
Board Hold-Down	Integrated y-snuggers, top clamps (software-enabled), underside centernest vacuum, venturi vacuum
Board Support Methods	Magnetic pins and blocks standard, dedicated workholders and Gel-Flex* optional
PRINT PARAMETERS	
Maximum Print Area (X x Y)	558 mm x 508 mm (22" x 20")
Snap-off	-0.025 mm to 12.7 mm (-0.001" to 0.500")
Print Speed	6 mm/sec to 305 mm/sec (0.25"/sec to 12"/sec)
Print Force	0.4 kg to 22 kg (0.9 lb to 50 lb)
Print Stroke	±280 mm (±11") from center
Stencil Frame Size	737 mm x 737 mm (29" x 29") adjustable to 584 mm x 584 mm

(23" x 23") for tubular frames. Optional stencil frame adapter for cast

VISION	
Vision Field-of-View (FOV)	10.6 mm x 8.0 mm
	(0.417" x 0.315")
Fiducial Types	Standard shape fiducials
	(see SMEMA standards),
	pad/aperture
Camera System	Single camera — patented
	look up/down vision
PERFORMANCE	
Total System Alignment	±12.5 microns
Accuracy and Repeatability	(±0.0005") at 6 sigma,
	Cpk of greater than or
	equal to 2.0*
Qualification is performed using pr	oduction environment
process variables; print speed, tab	le lift and camera
movement are included in the cap	ability figure.
Wet Print Deposit	±25 microns
Accuracy and Repeatability	(±0.001") at 6 sigma,
	Cpk of greater than or
	egual to 2.0*
Based upon actual wet printing wit	
Based upon actual wet printing wit and repeatability verified by a 3rd	th positional accuracy
	th positional accuracy
and repeatability verified by a 3rd	th positional accuracy
and repeatability verified by a 3rd system. Cycle Time	th positional accuracy party measurement
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and repeatability verified by a 3rd system. Cycle Time FACILITIES Power Requirements Air Supply Requirements Height (excluding light tower) Depth	th positional accuracy party measurement  Less than 5.5 sec  200 to 240 V AC (±10%) single phase @ 50/60Hz, 15. 100 psi at 4 cfm (standard run mode) to 18 cfm (vacuum wipe) (6.89 bar @ 1.9 L/s to 8.5 L/s), 12.7 mm (0.5") diameter line 1950 mm (76.7") max at tallest board load height 2169 mm (85.4")
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and repeatability verified by a 3rd system. Cycle Time FACILITIES Power Requirements Air Supply Requirements Height (excluding light tower) Depth Conveyor Width Front and Rear Clearance	th positional accuracy party measurement  Less than 5.5 sec  200 to 240 V AC (±10%) single phase @ 50/60Hz, 15. 100 psi at 4 cfm (standard run mode) to 18 cfm (vacuum wipe) (6.89 bar @ 1.9 L/s to 8.5 L/s), 12.7 mm (0.5") diameter line  1950 mm (76.7") max at tallest board load height 2169 mm (85.4")  Choice of 1416 mm (55.7"), 1727 mm (68"), or 2048 mm (80.6") 1357 mm (53.4")

\* The higher the Cp, the lower the variability with respect to the process specification limits. In a process qualified as a 6 Sigma

### ABOUT SPEEDLINE TECHNOLOGIES

Speedline Technologies is the global leader in process knowledge and expertise for the PCB assembly and semiconductor industries. Based in Franklin, Massachusetts, U.S.A., the company markets five best-in-class brands — Accel microelectronics cleaning equipment; Camalot dispensing systems; Electrovert wave soldering, reflow soldering, and cleaning equipment; MPM stencil and screen printing systems; and Protect global services, support, and training solutions. For more information, visit us at www.speedlinetech.com.

Speedline Technologies maintains an ongoing program of product improvement that may affect design and/or price. We reserve the right to make these changes without prior notice or liability.



**Knowledge in process**